# BT

### **Miniature Toggle Switch**

**RoHS Compliant** 

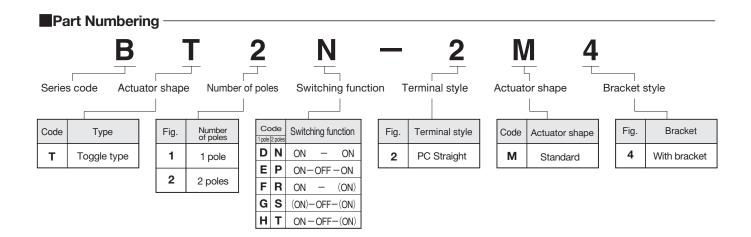


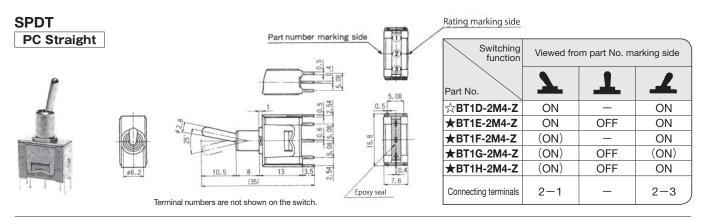
#### Features -

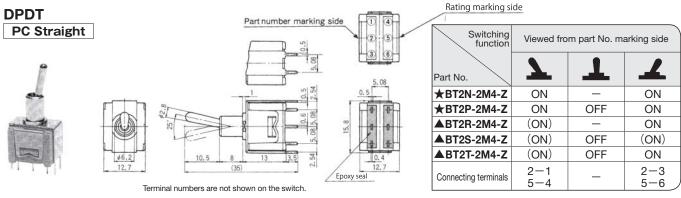
- 1. Terminal pin pitch: 2.54 mm.
- 2. Gold-plated contacts
- 3. Wiping contact mechanism for long-term reliability
- 4. Independent detent mechanism ensures light operational feel.
- 5. Epoxy-sealed terminal pins
- 6. Miniature size (Single-pole: 7.6mm, Double-pole: 12.7mm) for high density mounting.

### Specifications

Rating	Max.	50mA 20VAC · DC	
Initial contact resistance		50mΩ max.	$(1.5\text{mA} 200\mu\text{VAC})$
Dielectric strength		500VAC 1 minute	
Insulation resistance		10,000MΩ min.	(250VDC)
Electrical life		50,000 cycles	
Operating temperature range		-20°C~+85°C	
Storage temperature range		-40°C∼+85°C	







## **■PC Hole Layouts** 1-pole 10-φ0**.**8 2-poles

### Optional Accessories

**«Sold separately»** 

Color Cap (Round type)				
Dimensions	Color	Part. No.		
φ5 φ5 σi σi Vinyl chloride resin	White Red Black Gray	140000470030 140000470098 140000470031 140000470037		

0 1 0 (0 1 )					
Color Cap (Square type)					
Dimensions	Color	Part. No.			
Ø4.8 € 5 11 Ø3.8 Vinyl chloride resin	White Red Black Gray	140000470038 140000470100 140000470039 140000470077			

### ■ Soldering Specifications

(1)Manual Soldering

Device: Soldering iron 380°C, Max.; 3 seconds, Max.

(2)Auto Soldering

Device: Jet wave type or dip type 275°C, Max.; 3 seconds, Max.

- Pre-heating should be done at temperatures below 100°C and within 30 sec.
- (3)When soldering two or more terminals to the common land, use the solder resist to solder them independently.

### ■ Mounting of Switch

- ●Use PC boards with hole diameter of 0.8mm.
- Do not bend the terminal pins before mounting the switch on the PC board.
- After mounting the switch, do not place the device in such a way that the device weight will be applied on to the actuator of the switch.
- ●Do not apply load exceeding 29.4N to the actuator.

### Flux Cleaning -

(1)Solvent: Fluorine or Alcohol type.

- (2)The **BT** series are not washable. To wash the PC board, clean the soldering surface of PC board with a brush so that the switch is not exposed to the cleaning solution.
- (3)Cleaning after soldering should be done after the terminal temperature falls to 90°C or below, or after leaving the switch for five minutes or longer at room temperature.